### Features

- Single Supply Voltage, Range 3V to 3.6V
- 3-volt Only Read and Write Operation
- Software Protected Programming
- Low-power Dissipation
  - 15 mA Active Current
  - 50 µA CMOS Standby Current
- Fast Read Access Time 120 ns
- Sector Program Operation
  - Single-cycle Reprogram (Erase and Program)
    - 512 Sectors (128 Bytes/Sector)
    - Internal Address and Data Latches for 128 Bytes
- Fast Sector Program Cycle Time 20 ms Max
- Internal Program Control and Timer
- DATA Polling for End of Program Detection
- Typical Endurance > 10,000 Cycles
- CMOS and TTL Compatible Inputs and Outputs
- Green (Pb/Halide-free) Packaging Option

#### 1. Description

The AT29LV512 is a 3-volt-only in-system Flash programmable erasable read-only memory (PEROM). Its 512K of memory is organized as 65,536 words by 8 bits. Manufactured with Atmel's advanced nonvolatile CMOS technology, the device offers access times to 120 ns with power dissipation of just 54 mW over the industrial temperature range. When the device is deselected, the CMOS standby current is less than 50  $\mu$ A. The device endurance is such that any sector can typically be written to in excess of 10,000 times.

To allow for simple in-system reprogrammability, the AT29LV512 does not require high input voltages for programming. Three-volt-only commands determine the operation of the device. Reading data out of the device is similar to reading from an EPROM. Reprogramming the AT29LV512 is performed on a sector basis; 128 bytes of data are loaded into the device and then simultaneously programmed.

During a reprogram cycle, the address locations and 128 bytes of data are captured at microprocessor speed and internally latched, freeing the address and data bus for other operations. Following the initiation of a program cycle, the device will automatically erase the sector and then program the latched data using an internal control timer. The end of a program cycle can be detected by DATA polling of I/O7. Once the end of a program cycle has been detected, a new access for a read or program can begin.



# 512K (64K x 8) 3-volt Only Flash Memory

# AT29LV512

## Not Recommended for New Design

Contact Atmel to discuss the latest design in trends and options

01770-FLASH-9/08

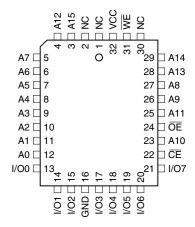




# 2. Pin Configurations

Pin Name	Function
A0 - A15	Addresses
CE	Chip Enable
ŌĒ	Output Enable
WE	Write Enable
I/O0 - I/O7	Data Inputs/Outputs
NC	No Connect

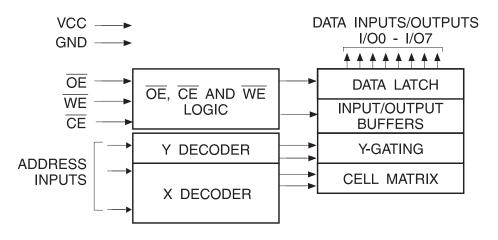
#### 2.1 32-lead PLCC Top View



#### 2.2 32-lead TSOP (Type 1) Top View

		((	
A11 🗔	1		32 🗔 OE
A9 🗔	20		31 🗖 A10
A8 🗔	3		30 🗔 🔁
A13 🗔	4		29 🗔 1/07
A14 🗔	5		28 🗔 I/O6
NC 🗌	6		27 🗔 I/O5
WE	7		26 🗔 I/O4
VCC	8		25 🗔 I/O3
NC 🖂	9		24 🗔 GND
NC 🗌	10		23 🗔 I/O2
A15 🗔	11		22 🗔 I/O1
A12	12		21 🗔 I/O0
A7 🗔	13		20 🗀 A0
A6 🗌	14		19 🗔 A1
A5 🗔	15		18 🗔 A2
A4 🗌	16	((	17 🗔 A3
		$\rightarrow$	

#### 3. Block Diagram



#### 4. Device Operation

#### 4.1 Read

The AT29LV512 is accessed like an EPROM. When  $\overline{CE}$  and  $\overline{OE}$  are low and  $\overline{WE}$  is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high impedance state whenever  $\overline{CE}$  or  $\overline{OE}$  is high. This dual-line control gives designers flexibility in preventing bus contention.

#### 4.2 Software Data Protection Programming

The AT29LV512 has 512 individual sectors, each 128 bytes. Using the software data protection feature, byte loads are used to enter the 128 bytes of a sector to be programmed. The AT29LV512 can only be programmed or reprogrammed using the software data protection feature. The device is programmed on a sector basis. If a byte of data within the sector is to be changed, data for the entire 128-byte sector must be loaded into the device. The AT29LV512 automatically does a sector erase prior to loading the data into the sector. An erase command is not required.

Software data protection protects the device from inadvertent programming. A series of three program commands to specific addresses with specific data must be presented to the device before programming may occur. After writing the three-byte command sequence (and after  $t_{WC}$ ), the entire device is protected. The same three program commands must begin each program operation. All software program commands must obey the sector program timing specifications. Power transitions will not reset the software data protection feature; however, the software feature will guard against inadvertent program cycles during power transitions.

Any attempt to write to the device without the 3-byte command sequence will start the internal write timers. No data will be written to the device; however, for the duration of  $t_{WC}$ , a read operation will effectively be a polling operation.

After the software data protection's 3-byte command code is given, a byte load is performed by applying a low pulse on the  $\overline{WE}$  or  $\overline{CE}$  input with  $\overline{CE}$  or  $\overline{WE}$  low (respectively) and  $\overline{OE}$  high. The address is latched on the falling edge of  $\overline{CE}$  or  $\overline{WE}$ , whichever occurs last. The data is latched by the first rising edge of  $\overline{CE}$  or  $\overline{WE}$ .





The 128 bytes of data must be loaded into each sector. Any byte that is not loaded during the programming of its sector will be erased to read FFh. Once the bytes of a sector are loaded into the device, they are simultaneously programmed during the internal programming period. After the first data byte has been loaded into the device, successive bytes are entered in the same manner. Each new byte to be programmed must have its high-to-low transition on  $\overline{WE}$  (or  $\overline{CE}$ ) within 150 µs of the low-to-high transition of  $\overline{WE}$  (or  $\overline{CE}$ ) of the preceding byte. If a high-to-low transition is not detected within 150 µs of the last low-to-high transition, the load period will end and the internal programming period will start. A7 to A15 specify the sector address. The sector address must be valid during each high-to-low transition of  $\overline{WE}$  (or  $\overline{CE}$ ). A0 to A6 specify the byte address within the sector. The bytes may be loaded in any order; sequential loading is not required. Once a programming operation has been initiated, and for the duration of  $t_{WC}$ , a read operation will effectively be a polling operation.

#### 4.3 Hardware Data Protection

Hardware features protect against inadvertent programs to the AT29LV512 in the following ways: (a)  $V_{CC}$  sense – if  $V_{CC}$  is below 1.8V (typical), the program function is inhibited; (b)  $V_{CC}$  power on delay – once  $V_{CC}$  has reached the  $V_{CC}$  sense level, the device will automatically time out 10 ms (typical) before programming; (c) Program inhibit – holding any one of  $\overline{OE}$  low,  $\overline{CE}$  high or  $\overline{WE}$  high inhibits program cycles; and (d) Noise filter – pulses of less than 15 ns (typical) on the  $\overline{WE}$  or  $\overline{CE}$  inputs will not initiate a program cycle.

#### 4.4 Input Levels

While operating with a 3.3V  $\pm$ 10% power supply, the address inputs and control inputs ( $\overline{OE}$ ,  $\overline{CE}$  and  $\overline{WE}$ ) may be driven from 0 to 5.5V without adversely affecting the operation of the device. The I/O lines can only be driven from 0 to 3.6 volts.

#### 4.5 Product Identification

The product identification mode identifies the device and manufacturer as Atmel. It may be accessed by hardware or software operation. The hardware operation mode can be used by an external programmer to identify the correct programming algorithm for the Atmel product. In addition, users may wish to use the software product identification mode to identify the part (i.e., using the device code), and have the system software use the appropriate sector size for program operations. In this manner, the user can have a common board design for 256K to 4-megabit densities and, with each density's sector size in a memory map, have the system software apply the appropriate sector size.

For details, see Operating Modes (for hardware operation) or Software Product Identification. The manufacturer and device code is the same for both modes.

#### 4.6 **DATA** Polling

The AT29LV512 features DATA polling to indicate the end of a program cycle. During a program cycle an attempted read of the last byte loaded will result in the complement of the loaded data on I/O7. Once the program cycle has been completed, true data is valid on all outputs and the next cycle may begin. DATA polling may begin at any time during the program cycle.

4

#### 4.7 Toggle Bit

In addition to DATA polling, the AT29LV512 provides another method for determining the end of a program or erase cycle. During a program or erase operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the program cycle has completed, I/O6 will stop toggling and valid data will be read. Examining the toggle bit may begin at any time during a program cycle.

#### 4.8 Optional Chip Erase Mode

The entire device can be erased by using a 6-byte software code. Please see Software Chip Erase application note for details.

#### 5. Absolute Maximum Ratings\*

Temperature Under Bias
Storage Temperature65°C to +150°C
All Input Voltages (including NC Pins) with Respect to Ground0.6V to +6.25V
All Output Voltages with Respect to Ground0.6V to $V_{CC}$ + 0.6V
Voltage on A9 (including NC Pins) with Respect to Ground0.6V to +13.5V

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability





## 6. DC and AC Operating Range

		AT29LV512-12
Operating Temperature (Case)	Industrial	-40°C - 85°C
V <sub>CC</sub> Power Supply <sup>(1)</sup>		$3.3V\pm0.3V$

Notes: 1. After power is applied and V<sub>CC</sub> is at the minimum specified data sheet value, the system should wait 20 ms before an operational mode is started.

### 7. Operating Modes

Mode	CE	ŌĒ	WE	Ai	I/O
Read	V <sub>IL</sub>	V <sub>IL</sub>	V <sub>IH</sub>	Ai	D <sub>OUT</sub>
Program <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IH</sub>	V <sub>IL</sub>	Ai	D <sub>IN</sub>
Standby/Write Inhibit	V <sub>IH</sub>	X <sup>(1)</sup>	Х	X	High Z
Program Inhibit	Х	Х	V <sub>IH</sub>		
Program Inhibit	X	V <sub>IL</sub>	Х		
Output Disable	Х	V <sub>IH</sub>	Х		High Z
Product Identification					
Hardware	V	V	M	A1 - A15 = $V_{IL}$ , A9 = $V_{H}^{(3)}$ , A0 = $V_{IL}$	Manufacturer Code <sup>(4)</sup>
Hardware	V <sub>IL</sub>	V <sub>IL</sub>	V <sub>IH</sub>	A1 - A15 = $V_{IL}$ , A9 = $V_{H}^{(3)}$ , A0 = $V_{IH}$	Device Code <sup>(4)</sup>
Software <sup>(5)</sup>				$A0 = V_{IL}$	Manufacturer Code <sup>(4)</sup>
Soliware				$A0 = V_{IH}$	Device Code <sup>(4)</sup>

Notes: 1. X can be  $V_{IL}$  or  $V_{IH}$ .

2. Refer to AC Programming Waveforms.

3.  $V_{H} = 12.0V \pm 0.5V.$ 

- 4. Manufacturer Code is 1F. The Device Code is 3D.
- 5. See details under Software Product Identification Entry/Exit.

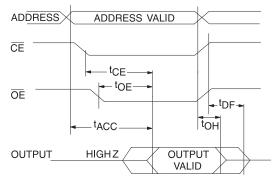
#### 8. DC Characteristics

Symbol	Parameter	Condition	Min	Max	Units
ILI	Input Load Current	$V_{IN} = 0V$ to $V_{CC}$		1	μA
I <sub>LO</sub>	Output Leakage Current	$V_{I/O} = 0V$ to $V_{CC}$		1	μA
I <sub>SB1</sub>	V <sub>CC</sub> Standby Current CMOS	$\overline{CE} = V_{CC} - 0.3V$ to $V_{CC}$		50	μA
I <sub>SB2</sub>	V <sub>CC</sub> Standby Current TTL	$\overline{CE}$ = 2.0V to V <sub>CC</sub>		1	mA
I <sub>cc</sub>	V <sub>CC</sub> Active Current	f = 5 MHz; I <sub>OUT</sub> = 0 mA; V <sub>CC</sub> = 3.6V		15	mA
V <sub>IL</sub>	Input Low Voltage			0.6	V
V <sub>IH</sub>	Input High Voltage		2.0		V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 1.6 mA; V <sub>CC</sub> = 3.0V		0.45	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -100 μA; V <sub>CC</sub> = 3.0V	2.4		V

### 9. AC Read Characteristics

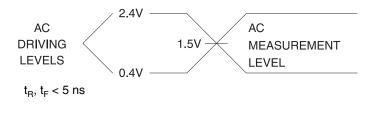
		AT29LV512-12		
Symbol	Parameter	Min	Max	Units
t <sub>ACC</sub>	Address to Output Delay		120	ns
t <sub>CE</sub> <sup>(1)</sup>	CE to Output Delay		120	ns
t <sub>OE</sub> <sup>(2)</sup>	OE to Output Delay	0	50	ns
t <sub>DF</sub> <sup>(3)(4)</sup>	CE or OE to Output Float	0	30	ns
t <sub>OH</sub>	Output Hold from OE, CE or Address, whichever occurred first	0		ns

### 10. AC Read Waveforms<sup>(1)(2)(3)(4)</sup>

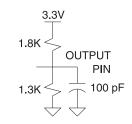


- Notes: 1.  $\overline{CE}$  may be delayed up to  $t_{ACC}$   $t_{CE}$  after the address transition without impact on  $t_{ACC}$ .
  - OE may be delayed up to t<sub>CE</sub> t<sub>OE</sub> after the falling edge of CE without impact on t<sub>CE</sub> or by t<sub>ACC</sub> t<sub>OE</sub> after an address change without impact on t<sub>ACC</sub>.
  - 3.  $t_{DF}$  is specified from  $\overline{OE}$  or  $\overline{CE}$  whichever occurs first (CL = 5 pF).
  - 4. This parameter is characterized and is not 100% tested.

#### **11. Input Test Waveforms and Measurement Level**



# 12. Output Test Load







#### 13. Pin Capacitance

f = 1 MHz, T =  $25^{\circ}C^{(1)}$ 

Symbol	Тур	Max Units		Conditions
C <sub>IN</sub>	4	6	pF	$V_{IN} = 0V$
C <sub>OUT</sub>	8	12	pF	$V_{OUT} = 0V$

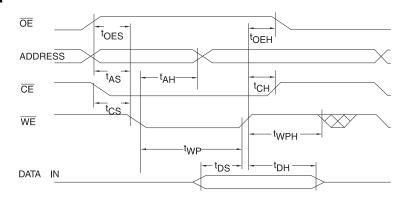
Note: 1. These parameters are characterized and not 100% tested.

#### 14. AC Byte Load Characteristics

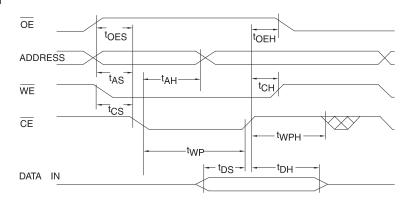
Symbol	Parameter	Min	Max	Units
t <sub>AS</sub> , t <sub>OES</sub>	Address, OE Set-up Time	0		ns
t <sub>AH</sub>	Address Hold Time	100		ns
t <sub>CS</sub>	Chip Select Set-up Time	0		ns
t <sub>CH</sub>	Chip Select Hold Time	0		ns
t <sub>WP</sub>	Write Pulse Width ( $\overline{WE}$ or $\overline{CE}$ )	200		ns
t <sub>DS</sub>	Data Set-up Time	100		ns
t <sub>DH</sub> , t <sub>OEH</sub>	Data, OE Hold Time	10		ns
t <sub>wPH</sub>	Write Pulse Width High	200		ns

# 15. AC Byte Load Waveforms<sup>(1)(2)</sup>

#### 15.1 WE Controlled



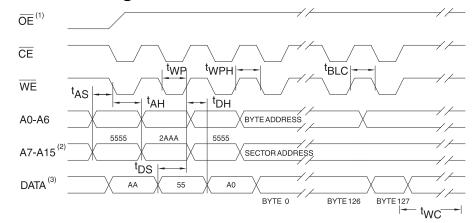
#### 15.2 CE Controlled



### 16. Program Cycle Characteristics

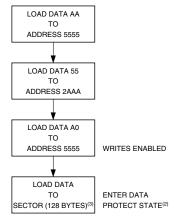
Symbol	Parameter	Min	Max	Units
t <sub>wc</sub>	Write Cycle Time		20	ms
t <sub>AS</sub>	Address Set-up Time	0		ns
t <sub>AH</sub>	Address Hold Time	100		ns
t <sub>DS</sub>	Data Set-up Time	100		ns
t <sub>DH</sub>	Data Hold Time	10		ns
t <sub>WP</sub>	Write Pulse Width	200		ns
t <sub>BLC</sub>	Byte Load Cycle Time		150	μs
t <sub>WPH</sub>	Write Pulse Width High	200		ns

#### 17. Software Protected Program Waveform<sup>(1)(2)(3)</sup>



- Notes: 1.  $\overline{OE}$  must be high when  $\overline{WE}$  and  $\overline{CE}$  are both low.
  - 2. A7 through A15 must specify the sector address during each high-to-low transition of WE (or CE) after the software code has been entered.
  - 3. All bytes that are not loaded within the sector being programmed will be indeterminate.

# **18. Programming Algorithm**<sup>(1)</sup>



- Notes: 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 A0 (Hex).
  - 2. Data Protect state will be re-activated at end of program cycle.
  - 3. 128 bytes of data **MUST BE** loaded.





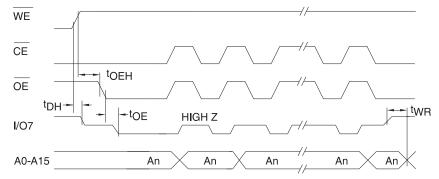
# 19. Data Polling Characteristics<sup>(1)</sup>

Symbol	Parameter	Min	Тур	Max	Units
t <sub>DH</sub>	Data Hold Time	10			ns
t <sub>OEH</sub>	OE Hold Time	10			ns
t <sub>OE</sub>	OE to Output Delay <sup>(2)</sup>				ns
t <sub>wR</sub>	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See  $t_{OE}$  spec in AC Read Characteristics.

## 20. Data Polling Waveforms



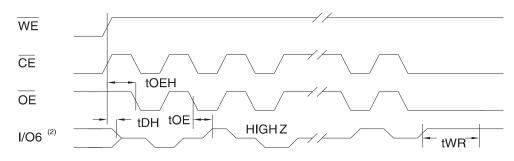
## 21. Toggle Bit Characteristics<sup>(1)</sup>

Symbol	Parameter	Min	Тур	Max	Units
t <sub>DH</sub>	Data Hold Time	10			ns
t <sub>OEH</sub>	OE Hold Time	10			ns
t <sub>OE</sub>	OE to Output Delay <sup>(2)</sup>				ns
t <sub>OEHP</sub>	OE High Pulse	150			ns
t <sub>WR</sub>	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See t<sub>OE</sub> spec in AC Read Characteristics.

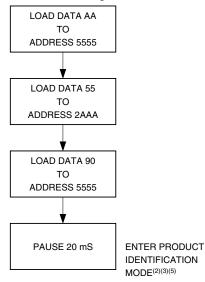
## 22. Toggle Bit Waveforms<sup>(1)(3)</sup>



Notes: 1. Toggling either  $\overline{OE}$  or  $\overline{CE}$  or both  $\overline{OE}$  and  $\overline{CE}$  will operate toggle bit.

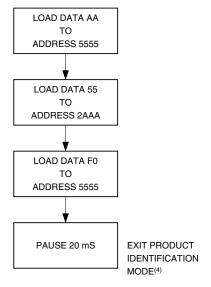
- 2. Beginning and ending state of I/O6 will vary.
- 3. Any address location may be used but the address should not vary.

# 23. Software Product Identification Entry<sup>(1)</sup>



- Notes: 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 A0 (Hex).
  - 2. A1 A15 =  $V_{IL}$ . Manufacturer Code is read for A0 =  $V_{IL}$ ; Device Code is read for A0 =  $V_{IH}$ .
  - 3. The device does not remain in identification mode if powered down.
  - 4. The device returns to standard operation mode.
  - 5. Manufacturer Code is 1F. The Device Code is 3D.

#### 24. Software Product Identification Exit<sup>(1)</sup>







# 25. Ordering Information

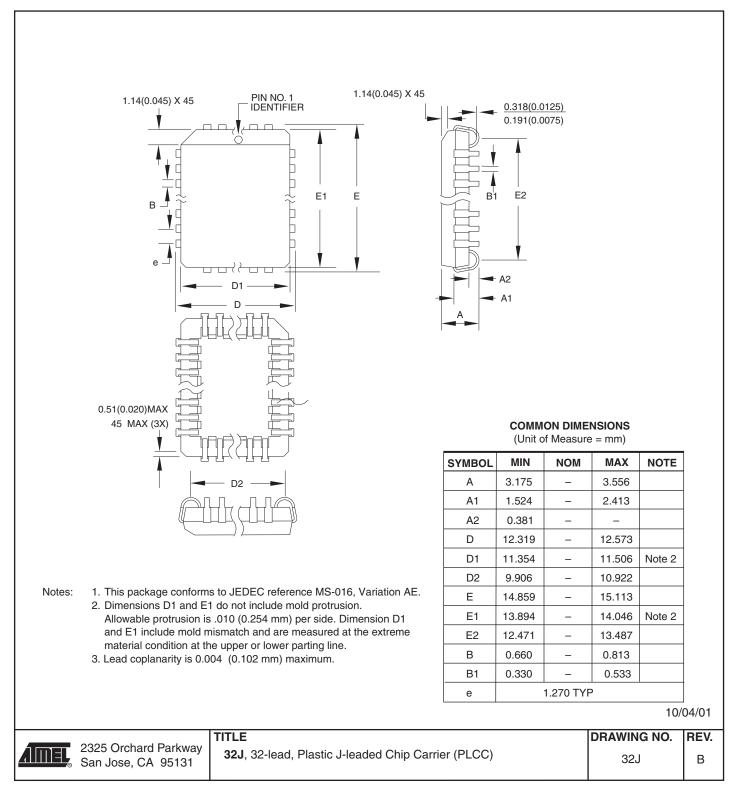
# 25.1 Green Package Option (Pb/Halide-free)

t <sub>A</sub>	t <sub>ACC</sub>	l <sub>cc</sub> (mA)				
(n	s)	Active	Standby	Ordering Code	Package	Operation Range
12	20	15	0.05	AT29LV512-12JU	32J	Industrial
				AT29LV512-12TU	32T	(-40° to 85°C)

Package Type				
32J	32-lead, Plastic J-leaded Chip Carrier (PLCC)			
32T	32-lead, Thin Small Outline Package (TSOP)			

#### 26. Packaging Information

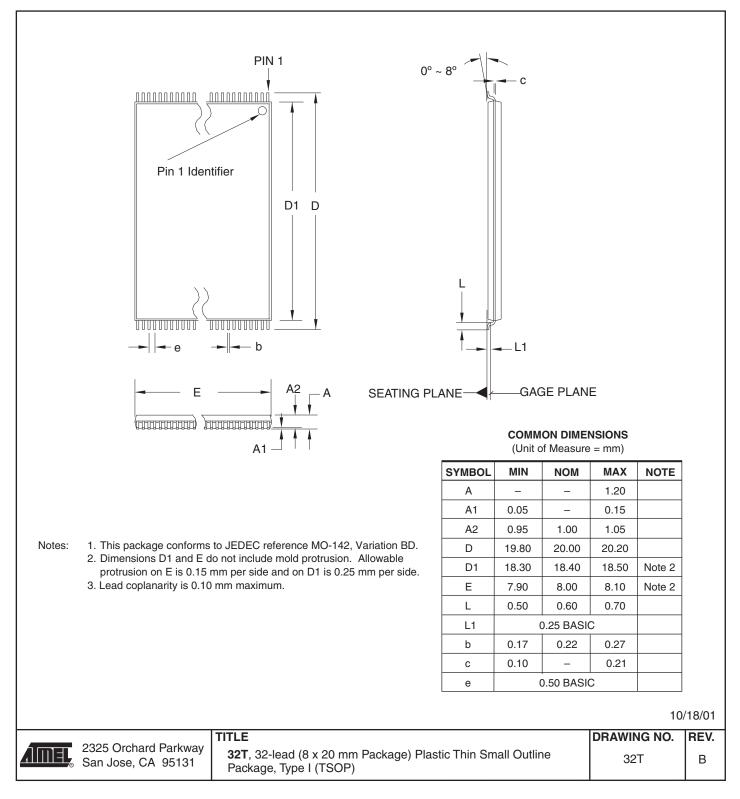








#### 26.2 32T - TSOP





#### Headquarters

*Atmel Corporation* 2325 Orchard Parkway San Jose, CA 95131 USA Tel: 1(408) 441-0311 Fax: 1(408) 487-2600

#### International

Atmel Asia Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimshatsui East Kowloon Hong Kong Tel: (852) 2721-9778 Fax: (852) 2722-1369 Atmel Europe Le Krebs 8, Rue Jean-Pierre Timbaud BP 309 78054 Saint-Quentin-en-Yvelines Cedex France Tel: (33) 1-30-60-70-00 Fax: (33) 1-30-60-71-11

#### Atmel Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan Tel: (81) 3-3523-3551 Fax: (81) 3-3523-7581

#### **Product Contact**

Web Site www.atmel.com *Technical Support* Flash@atmel.com Sales Contact www.atmel.com/contacts

Literature Requests www.atmel.com/literature

Disclaimer: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN ATMEL'S TERMS AND CONDI-TIONS OF SALE LOCATED ON ATMEL'S WEB SITE, ATMEL ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDEN-TAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS OF PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and product descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel's products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

© 2008 Atmel Corporation. All rights reserved. Atmel<sup>®</sup>, Atmel logo and combinations thereof, and others are registered trademarks or trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be trademarks of others.